AN5031

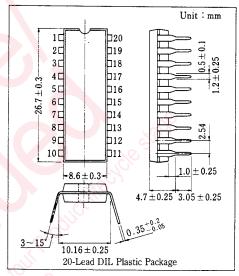
TV Tuning Control Circuit

Outline

The AN5031 is an integrated circuit designed for tuner control circuit of TV electronic tuning system using a semiconductor memory.

Features

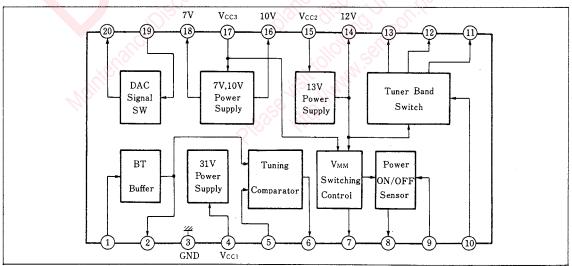
- Consists of peripheral part of electronic tuning system with semiconductor memories
- Electronic tuner power supply circuit incorporated
- Reference voltage stabilizer for electronic tuning incorporated



Pin

Pin No.	Pin Name	Pin No.	Pin Name
1	BT Voltage Input	11	BU Output
2	BT Voltage Output	(12	BV Output
3	GND	13	BS Output
4	31V Regulator (Vcci)	14	13V Power Supply Output
5	Pre-set Voltage Input	15	V _{CC2}
6	Tuning Control Output	16	10V Power Supply Output
7	Switching Output	17	V _{cc3}
8	Power CLR Output	18	7V Power Supply Output
9	Power ON-OFF Sensor Input	19	DAC Signal Input
10	Band SW Input	20	DAC Signal Output

Block Diagram



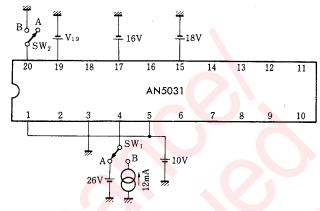
■ Absolute Maximum Ratings (Ta=25°C)

Item			Symbol	Rat	ing	Unit	
-	V _{CC2}		V ₁₅₋₃	2	4	V	
X7-14	Supply Voltage	Vccs	V_{17-3}	2	4	V	
Voltage	Circuit Voltage		V_{13-3}	0	+27	V	
			V ₁₉₋₃	0	+ 8	V	
	Supply Current		I ₄	0	+15	· mA	
			I ₁₁ , I ₁₂	- 25	0	mA	
Current	Circuit Current		I ₁₃	0	+22	mA	
Current			. I14	-20	+50	mA	
			I_{16}	-20	+ 7	mA	
			I_{18}	-50	+0.5	mA	
Power Dissipation		P _D	10	50	mW		
Tamanamatuma	Operating Ambient Temerature		Topr	-20~	~+70	C	
Temperature	Storage Temperature		$T_{ m stg}$	-55^	~+150	C	

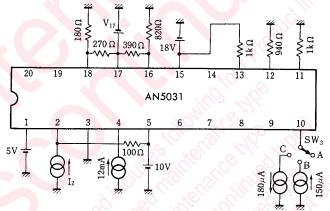
■ Electrical Characteristics (Ta=25°C)

Item	Symbol	Test Circuit	Condition		typ.	max.	Unit	
V _{cc1} Circuit Current		I_4	1	$S_1=A, V_{19}=0, S_2=A$		5.1	6.3	mA
V _{cc2} Circuit Current		I ₁₅	1	$S_1=B, V_{19}=0, S_2=A$		11.5	14.5	mA
V _{CC3} Circuit Current		I ₁₇	1	$S_1=B, V_{19}=0, S_2=A$		8.4	10.9	mA
DAI Input Current		I ₁₉	1	$S_1=B, V_{18}=4V, S_2=A$		2.1	2.8	mA
LFO Output Current		$-I_{20}$	10	$S_1=B, V_{19}=0, S_2=B$		1.1	1.8	m A
BTI Input Current		I_1	1	$S_1=B, V_{19}=0, S_2=A$		-0.1	0	μΑ
BTI-BTO Voltege Difference		V ₁₋₂	1	$S_1=B, V_{19}=0, S_2=A$		0.18	0.36	V
VRI Input Current		I_5	J	$S_1=B, V_{19}=0, S_2=A$	-20	- 5	0	μΑ
	"L"	V _{6-3(L)}	2	$I_2=150 \mu A, S_3=A, V_{17}=16V$	0	0.23	0.5	V
TUD Output Voltage	"M"	V _{6-3(M)}	2	$I_2 = -420 \mu A$, $S_3 = A$, $V_{17} = 16V$		5.0	5.5	V
	"H"	V _{6-16(H)}	2	$I_2 = -1.1 \text{mA}, S_3 = A, V_{17} = 16 \text{V}$	-0.5	-0.2	0	V
BSI Terminal Voltage		V_{10-3}	2	$I_2=0$, $S_3=A$, $V_{17}=10.7V$		5.2	5.8	V
BUO Output Voltage		V ₁₁₋₃	2	$I_2=0$, $S_3=B$, $V_{17}=10.7V$		12.3	13.1	V
BVO Output Voltage		V_{12-3}	2	$I_2=0$, $S_3=A$, $V_{17}=10.7V$		12.3	13.1	V
BSO Output Voltage		V ₁₃₋₃	2	$I_2=0$, $S_3=A$, $V_{17}=10.7V$		0.5	1.2	V
BSO Output Current	I ₁₃	2	$I_2=0$, $S_3=C$, $V_{17}=10.7V$			1	μΑ	
13V Power Output Voltage	V ₁₄₋₃	2	$I_2=0$, $S_3=A$, $V_{17}=10.7V$		13.5	14.3	V	
10V Power Output Voltage	V_{16-3}	2	$I_2=0$, $S_3=A$, $V_{17}=10.7V$		9.9	10.7	V	
7V Power Output Voltage	V ₁₈₋₃	2	I ₂ =0, S ₃ =A, V ₁₇ =16V		7.4	8.0	V	
V _{CC1} Voltage Regulator		V ₄₋₃	1	$S_1=B$, $V_{19}=0$, $S_2=A$		31.5	33.5	V
V _{CC1} Operating Resistance	r ₄	1	$S_1=B, V_{19}=0, S_2=A$		10	25	Ω	

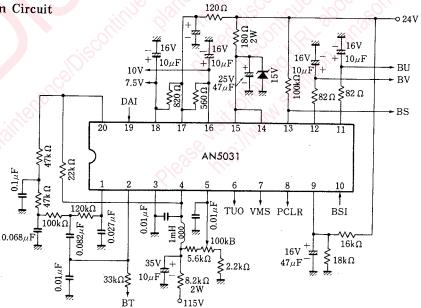
Test Circuit 1 $(I_{1,4,5,15,17,19},\; -I_{20,}V_{1-2}\,,\,V_{4-3}\,,\;r_4\,)$



 $\textbf{Test Circuit 2} \ (V_{6-3(L)}, V_{6-3(M)}, V_{6-16(H)}, V_{10,\,11,\,12,\,13,\,14,\,16,\,18-3}\,,\, I_{13})$







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